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August 2001 Revised December 2001

FIN1032

3.3V LVDS 4-Bit High Speed Differential Receiver

General Description

This quad receiver is designed for high speed interconnect utilizing Low Voltage Differential Signaling (LVDS) technology. The receiver translates LVDS levels, with a typical differential input threshold of 100mV, to LVTTL signal levels. LVDS provides low EMI at ultra low power dissipation even at high frequencies. This device is ideal for high speed transfer of clock and data.

The FIN1032 can be paired with its companion driver, the FIN1031, or any other Fairchild LVDS driver.

Features

- Greater than 400Mbs data rate
- 3.3V power supply operation
- 0.4ns maximum differential pulse skew
- 2.5ns maximum propagation delay
- Low power dissipation
- Power OFF protection
- Fail safe protection for open-circuit, shorted and terminated conditions
- Meets or exceeds the TIA/EIA-644 LVDS standard
- Pin compatible with equivalent RS-422 and LVPECL devices
- 16-Lead SOIC and TSSOP packages save space

Ordering Code:

Order Number	Package Number	Package Description	
FIN1032M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow	
FIN1032MTC	MTC16	16-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide	

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

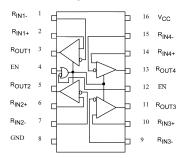
Function Table

	Outputs				
EN	EN	R _{IN+}	R _{OUT}	R _{OUT}	
Н	Х	H L		Н	
Н	Х	L	Н	L	
Н	Х	Fail Safe Condition		Н	
Х	L	Н	L	Н	
Х	L	L	Н	L	
Х	L	Fail Safe Condition		Н	
L	Н	X		Z	

H = HIGH Logic Level L = Z = High Impedance Fail

L = LOW Logic Level X = Don't Care Fail Safe = Open, Shorted, Terminated

Connection Diagram



Pin Descriptions

Pin Name	Description
R _{OUT1} , R _{OUT2} , R _{OUT3} , R _{OUT4}	LVTTL Data Outputs
$R_{IN1+}, R_{IN2+}, R_{IN3+}, R_{IN4+}$	Non-Inverting LVDS Inputs
$R_{IN1-}, R_{IN2-}, R_{IN3-}, R_{IN4-}$	Inverting LVDS Inputs
EN	Driver Enable Pin
EN	Inverting Driver Enable Pin
V _{CC}	Power Supply
GND	Ground

Absolute Maximum Ratings(Note 1)

$\begin{array}{lll} \mbox{Supply Voltage (V$_{CC}$)} & -0.5\mbox{V to } +4.6\mbox{ V} \\ \mbox{DC Input Voltage (V$_{OT}$)} & -0.5\mbox{V to } +4.6\mbox{ V} \\ \mbox{DC Input Voltage (V$_{OUT}$)} & -0.5\mbox{V to } 6\mbox{ V} \\ \end{array}$

DC Output Current (I_O) 16 mA Storage Temperature Range (T_{STG}) -65° C to +150 $^{\circ}$ C Max Junction Temperature ($T_{,i}$) 150 $^{\circ}$ C

Max Junction Temperature (T_J)
Lead Temperature (T_L)

(Soldering, 10 seconds) 260°C ESD (Human Body Model) \geq 10,000 V ESD (Machine Model) \geq 500 V

Recommended Operating Conditions

Supply Voltage (V_{CC}) 3.0 V to 3.6 V

Magnitude of Differential Voltage

 $\begin{array}{ll} (|V_{ID}|) & 100 \text{ mV to V}_{CC} \\ \text{Common-Mode Input Voltage } (V_{IC}) & 0.05 \text{ V to 2.35V} \\ \text{Input Voltage } (V_{IN}) & 0 \text{ to V}_{CC} \\ \text{Operating Temperature } (T_A) & -40^{\circ}\text{C to } +85^{\circ}\text{C} \\ \end{array}$

Note 1: The "Absolute Maximum Ratings": are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature and output/input loading variables. Fairchild does not recommend operation of circuits outside databook specification.

DC Electrical Characteristics

Over supply voltage and operating temperature ranges, unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ (Note 2)	Max	Units
V _{TH}	Differential Input Threshold HIGH	See Figure 1 and Table 1			100	mV
V _{TL}	Differential Input Threshold LOW	See Figure 1 and Table 1	-100			mV
I _{IN}	Input Current	V _{IN} = 0V or V _{CC}			±20	μΑ
I _{I(OFF)}	Power-OFF Input Current	V _{CC} = 0V, V _{IN} = 0V or 3.6V			±20	μΑ
V _{IH}	Input High Voltage (EN or EN)		2.0		V _{CC}	V
V _{IL}	Input Low Voltage (EN or EN)		GND		0.8	V
V _{OH}	Output HIGH Voltage	$I_{OH} = -100 \mu\text{A}$	V _{CC} -0.2			V
		$I_{OH} = -8 \text{ mA}$	2.4			\ \ \
V _{OL}	Output LOW Voltage	$I_{OH} = 100 \mu A$			0.2	V
		I _{OL} = 8 mA			0.5	\ \ \
V _{IK}	Input Clamp Voltage	$I_{IK} = -18 \text{ mA}$	-1.5			V
I _{OZ}	Disabled Output Leakage Current	$EN = 0.8$ and $\overline{EN} = 2V$, $V_{OUT} = 3.6V$ or $0V$			±20	μΑ
I _{OS}	Output Short Circuit Test	Receiver Enabled, V _{OUT} = 0V (one output shorted at a time)	-15		-100	mA
I _{CCZ}	Disabled Power Supply Current	Receiver Disabled			5	mA
I _{CC}	Power Supply Current	Receiver Enabled, (R_{IN+} = 1V and R_{IN-} = 1.4V) or (R_{IN+} = 1.4V and R_{IN-} = 1V)			15	mA
I _{PU/PD}	Output Power Up/Power Down	V _{CC} = 0V to 1.5V			±20	μΑ
	High Z Leakage Current					
C _{IN}	Input Capacitance			3.5		pF
C _{OUT}	Output Capacitance			6		pF

Note 2: All typical values are at $T_A = 25^{\circ}C$ and with $V_{CC} = 3.3V$.

AC Electrical Characteristics

Over supply voltage and operating temperature ranges, unless otherwise specified

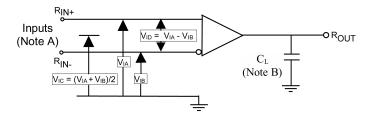
Symbol	Parameter	Test Conditions	Min	Typ (Note 3)	Max	Units
t _{PLH}	Propagation Delay LOW-to-HIGH		1.0		2.5	ns
t _{PHL}	Propagation Delay HIGH-to-LOW	7	1.0		2.5	ns
t _{TLH}	Output Rise Time (20% to 80%)	$ V_{ID} = 400 \text{ mV}, C_L = 10 \text{ pF},$		0.7	1.2	ns
t _{THL}	Output Fall Time (80% to 20%)	$R_L = 1k\Omega$		0.7	1.2	ns
t _{SK(P)}	Pulse Skew t _{PLH} - t _{PHL}	See Figure 1 and Figure 2			0.4	ns
t _{SK(LH)}	Channel-to-Channel Skew (Note 4)				0.3	ns
t _{SK(PP)}	Part-to-Part Skew (Note 5)	7			1.0	ns
f _{MAX}	Maximum Operating Frequency (Note 6)	$R_L = 1k\Omega$, $C_L = 10$ pF, see Figure 1 and Figure 2	200	325		MHz
t _{ZH}	LVTTL Output Enable Time from Z to HIGH				5.0	ns
t _{ZL}	LVTTL Output Enable Time from Z to LOW	$R_L = 1k\Omega$, $C_L = 10 pF$,			5.0	ns
t _{HZ}	LVTTL Output Disable Time from HIGH to Z	See Figure 3 and Figure 4			5.0	ns
t _{LZ}	LVTTL Output Disable Time from LOW to Z	7			5.0	ns

Note 3: All typical values are at $T_A = 25$ °C and with $V_{CC} = 3.3$ V.

Note 4: $t_{SK(LH)}$, $t_{SK(HL)}$ is the skew between specified outputs of a single device when the outputs have identical loads and are switching in the same direction.

Note 5: $t_{SK(PP)}$ is the magnitude of the difference in propagation delay times between any specified terminals of two devices switching in the same direction (either LOW-to-HIGH or HIGH-to-LOW) when both devices operate with the same supply voltage, same temperature, and have identical test circuits.

Note 6: f_{MAX} Criteria: Input $t_R = t_F < 1$ ns, $V_{ID} = 300$ mV, (1.05V to 1.35V pp), 50% duty cycle; Output duty cycle 40% to 60%, $V_{OL} < 0.5$ V, $V_{OH} > 2.4$ V. All channels switching in phase.



Note A: All input pulses have frequency = 10MHz, t_R or t_F = 1ns

Note B: C_L includes all probe and jig capacitances

FIGURE 1. Differential Receiver Voltage Definitions and Propagation Delay and Transition Time Test Circuit

TABLE 1. Receiver Minimum and Maximum Input Threshold Test Voltages

Applied Voltages (V)		Resulting Differential Input Voltage (mA)	Resulting Common Mode Input Voltage (V)		
			- ' '		
VIA	V _{IB}	V _{ID}	V _{IC}		
1.25	1.15	100	1.2		
1.15	1.25	-100	1.2		
2.4	2.3	100	2.35		
2.3	2.4	-100	2.35		
0.1	0	100	0.05		
0	0.1	-100	0.05		
1.5	0.9	600	1.2		
0.9	1.5	-600	1.2		
2.4	1.8	600	2.1		
1.8	2.4	-600	2.1		
0.6	0	600	0.3		
0	0.6	-600	0.3		

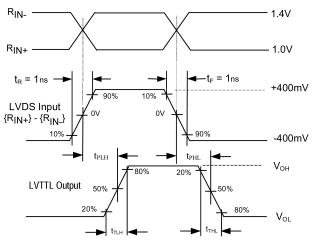


FIGURE 2. LVDS Input to LVTTL Output AC Waveforms

Test Circuit for LVTTL Outputs

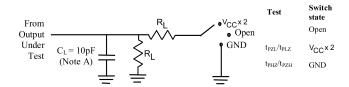
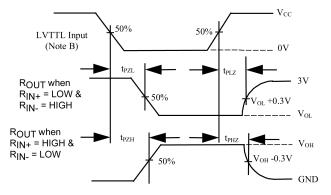


FIGURE 3. AC Loading Circuit for LVTTL Outputs

Voltage Waveforms Enable and Disable Times

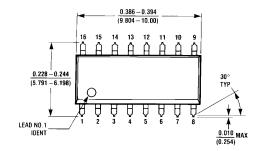


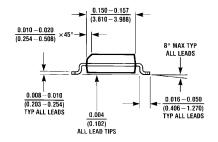
Note A: C_L includes probes and jig capacitance

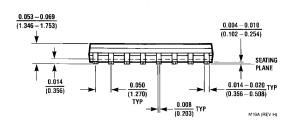
 $\textbf{Note B:} \ \text{All LVTTL input pulses have the following characteristics: Frequency} = 10 \ \text{MHz} \ t_R \ \text{or} \ t_F \leq 2 \ \text{ns}$

FIGURE 4. LVTTL Outputs Test Circuit and AC Waveforms

Physical Dimensions inches (millimeters) unless otherwise noted







16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow Package Number M16A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued) 7.72 TYP. DIMENSIONS METRIC ONLY (1.78 TYP) 0.42 TYP LAND PATTERN RECOMMENDATION GAGE PLANE 6.4 0.25 4.4 ± 0.1 -B-3.2 SEATING PLANE 0.6 ± 0.1 DETAIL A TYPICAL, SCALE: 40X △ 0.2 C B A ALL LEAD TIPS PIN #1 IDENT SEE DETAIL A (0.90)□ 0.1 C ALL LEAD TIPS -C-0.65 TYP 0.10 ± 0.05 TYP 0.09-0.20 TYP 0.30 TYP Ф 0.13 M Α B (S) c (S) MTC16 (REV C)

16-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC16

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